## onsemi

## Automotive 750 V, 800 A Dual Side Cooling Half-Bridge Power Module

## VE-Trac<sup>™</sup> Dual Gen II NVG800A75L4DSB2

#### **Product Description**

The NVG800A75L4DSB2 is part of a family of power modules with dual side cooling and compact footprints for Hybrid (HEV) and Electric Vehicle (EV) traction inverter application.

The module consists of two narrow mesa Field Stop (FS4) IGBTs in a half-bridge configuration. The chipset utilizes the new narrow mesa IGBT technology in providing high current density and robust short circuit protection with higher blocking voltage to deliver outstanding performance in EV traction applications.

Liquid cooling heatsink reference design, loss models and CAD models are available to support customers in inverter designs.

#### Features

- Dual-Side Cooling
- Integrated Chip Level Temperature and Current Sensor
- T<sub>vi max</sub> = 175°C for Continuous Operation
- Low-stray Inductance
- Low Conduction and Switching Losses
- Automotive Grade
- 4.2 kV Isolated DBC Substrate
- AEC Qualified and PPAP Capable
- This Device is Pb-Free and is RoHS Compliant

#### **Typical Applications**

- Hybrid and Electric Vehicle Traction Inverter
- High Power DC-DC Converter



AHPM15-CEC CASE MODHV

#### MARKING DIAGRAM



XXXX = Specific Device Code



#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 5 of this data sheet.

## **PIN DESCRIPTION**

Pin #	Pin	Pin Function Description	Pin Arrangement
1	Ν	Low Side Emitter	2
2	Р	High Side Collector	9
3	H/S COLLECTOR SENSE	High Side Collector Sense	3 0
4	H/S CURRENT SENSE	High Side Current Sense	
5	H/S EMITTER SENSE	High Side Emitter Sense	
6	H/S GATE	High Side Gate	
7	H/S TEMP SENSE (CATHODE)	High Side Temp sense Diode Cathode	
8	H/S TEMP SENSE (ANODE)	High Side Temp sense Diode Anode	8 O 9
9	~	Phase Output	15 0
10	L/S CURRENT SENSE	Low Side Current Sense	
11	L/S EMITTER SENSE	Low Side Emitter Sense	
12	L/S GATE	Low Side Gate	
13	L/S TEMP SENSE (CATHODE)	Low Side Temp sense Diode Cathode	
14	L/S TEMP SENSE (ANODE)	Low Side Temp sense Diode Anode	
15	L/S COLLECTOR SENSE	Low Side Collector Sense	ĩ

## Materials

DBC Substrate: Al<sub>2</sub>O<sub>3</sub> isolated substrate, basic isolation, and copper on both sides.

#### Lead Frame

Copper with Tin electro-plating.

### Flammability Information

All materials present in the power module meet UL flammability rating class 94V-0.

### **MODULE CHARACTERISTICS**

Symbol	Parameter		Rating	Unit	
T <sub>vj</sub>	Continuous Operating Junction Temperature Range		-40 to 175	°C	
T <sub>STG</sub>	Storage Temperature range	Storage Temperature range			
V <sub>ISO</sub>	Isolation Voltage, AC, f = 50 Hz, t = 1 s			4200	V
Creepage	Minimum: Terminal to Terminal			5.0	mm
Clearance	Minimum: (Note 1) Terminal to Terminal				mm
CTI	Comparative Tracking Index	>600			
		Min	Тур	Max	
L <sub>sCE</sub>	Stray Inductance 8				nH
R <sub>CC'+EE'</sub>	Module Lead Resistance, Terminals – Chip 0.15			mΩ	
G	Module Weight 75			g	
М	M4 Screws for Module Terminals			2.2	Nm

1. Verified by design / not by test.

### ABSOLUTE MAXIMUM RATINGS (T<sub>VJ</sub> = 25°C, Unless Otherwise Specified)

Symbol	Parameter	Rating	Unit						
IGBT									
V <sub>CES</sub>	Collector to Emitter Voltage	750	V						
V <sub>GES</sub>	Gate to Emitter Voltage	±20	V						
I <sub>CN</sub>	Implemented Collector Current	800	A						
I <sub>C nom</sub>	Continuous DC Collector Current, $Tv_{Jmax} = 175^{\circ}C$ , $T_F = 65^{\circ}C$ , ref. heatsink	550 <sup>(1)</sup>	A						
I <sub>CRM</sub>	Pulsed Collector Current @ VGE = 15 V, t <sub>p</sub> = 1 ms	1600	A						

DIODE

V <sub>RRM</sub>	Repetitive peak reverse voltage	750	V
I <sub>FN</sub>	Implemented Forward Current		А
١ <sub>F</sub>	Continuous Forward Current, $Tv_{Jmax} = 175^{\circ}C$ , $T_F = 65^{\circ}C$ , ref. heatsink	420 (1)	А
I <sub>FRM</sub>	Repetitive Peak Forward Current, t <sub>p</sub> = 1 ms	1600	А
l <sup>2</sup> t value	Surge current capability, $V_R = 0 V$ , $t_p = 10 ms$ , $Tv_J = 150^{\circ}C$ $T_{VJ} = 175^{\circ}C$	20000 18000	A <sup>2</sup> s

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 2. Verified by characterization, not by test.

## THERMAL CHARACTERISTICS (Verified by characterization, not by test.)

Symbol	Parameter	Min	Тур	Max	Unit
IGBT.R <sub>th,J-C</sub>	Effective Rth, Junction to Case <sup>(3)</sup>		0.05	0.07	°C/W
IGBT.R <sub>th,J-F</sub>	Effective Rth, Junction to Fluid, $\lambda_{TIM} = 6$ W/m–K, F = 660 N 10 L/min, 65°C, 50/50 EGW, Ref. Heatsink		0.128		°C/W
Diode.R <sub>th,J-C</sub>	Effective Rth, Junction to Case <sup>(3)</sup>		0.07	0.09	°C/W
Diode.R <sub>th,J-F</sub>	Effective Rth, Junction to Fluid, $\lambda_{TIM} = 6$ W/m–K, F = 660 N 10 L/min, 65°C, 50/50 EGW, Ref. Heatsink		0.186		°C/W

3. For the measurement point of case temperature (Tc), DBC discoloration, picker circle print is allowed, please refer to the VE-Trac Dual assembly guide for additional details about acceptable DBC surface finish.

#### **CHARACTERISTICS OF IGBT** (Tvj = 25°C, Unless Otherwise Specified)

	Parameters	Conditions	Min	Тур	Max	Unit
V <sub>CESAT</sub>	Collector to Emitter Saturation Voltage (Terminal)	$V_{GE} = 15 \text{ V}, \text{ I}_{C} = 600 \text{ A}, \text{ Tv}_{J} = 25^{\circ}\text{C}$ $\text{Tv}_{J} = 150^{\circ}\text{C}$ $\text{Tv}_{J} = 175^{\circ}\text{C}$	-	1.30 1.42 1.44	1.69	V
		$V_{GE}$ = 15 V, I <sub>C</sub> = 800 A, Tv <sub>J</sub> = 25°C Tv <sub>J</sub> = 150°C Tv <sub>J</sub> = 175°C		1.43 1.63 1.66		
I <sub>CES</sub>	Collector to Emitter Leakage Current	$V_{GE} = 0, V_{CE} = 750 \text{ V} \qquad Tv_J = 25^{\circ}C \\ Tv_J = 175^{\circ}C$		- 8	1 -	mA mA
I <sub>GES</sub>	Gate – Emitter Leakage Current	$V_{CE} = 0, V_{GE} = \pm 20 V$	-	_	±400	nA
V <sub>th</sub>	Threshold Voltage	$V_{CE=} V_{GE}$ , $I_C = 500 \text{ mA}$	4.5	5.5	6.5	V
Q <sub>G</sub>	Total Gate Charge	V <sub>GE=</sub> -8 to 15 V, V <sub>CE</sub> = 400 V	-	1.7	_	μC
R <sub>Gint</sub>	Internal gate resistance		_	2	_	Ω
Cies	Input Capacitance	V <sub>CE</sub> = 30 V, V <sub>GE</sub> = 0 V, f = 100 KHz	_	43	_	nF
C <sub>oes</sub>	Output Capacitance	V <sub>CE</sub> = 30 V, V <sub>GE</sub> = 0 V, f = 100 KHz	-	1.48	_	nF
C <sub>res</sub>	Reverse Transfer Capacitance	V <sub>CE</sub> = 30 V, V <sub>GE</sub> = 0 V, f = 100 KHz	-	0.19	_	nF
T <sub>d.on</sub>	Turn on delay, inductive load	$\label{eq:loss} \begin{array}{ll} I_{C} = 600 \; \text{A},  V_{CE} = 400 \; \text{V} & \mbox{Tv}_{J} = 25^{\circ} \text{C} \\ V_{GE} = +15/\!-\!8 \; \text{V} & \mbox{Tv}_{J} = 150^{\circ} \text{C} \\ \text{Rg.on} = 4.7 \; \Omega & \mbox{Tv}_{J} = 175^{\circ} \text{C} \end{array}$	-	377 382 382	_	ns
T <sub>r</sub>	Rise time, inductive load	$\label{eq:VGE} \begin{array}{ll} I_C = 600 \; \text{A},  V_{CE} = 400 \; \text{V} & \mbox{Tv}_J = 25^\circ \text{C} \\ V_{GE} = +15/\!-\!8 \; \text{V} & \mbox{Tv}_J = 150^\circ \text{C} \\ \text{Rg.on} = 4.7 \; \Omega & \mbox{Tv}_J = 175^\circ \text{C} \end{array}$	-	104 127 132	-	ns
T <sub>d.off</sub>	Turn off delay, inductive load	$\label{eq:VGE} \begin{array}{ll} I_C = 600 \; \text{A},  V_{CE} = 400 \; \text{V} & \mbox{Tv}_J = 25^\circ \mbox{C} \\ V_{GE} = +15/\!-\!8 \; \text{V} & \mbox{Tv}_J = 150^\circ \mbox{C} \\ \mbox{Rg.off} = 15 \; \Omega & \mbox{Tv}_J = 175^\circ \mbox{C} \end{array}$	-	917 1042 1075	-	ns
Т <sub>f</sub>	Fall time, inductive load	$\label{eq:VC} \begin{array}{ll} I_C = 600 \; A,  V_{CE} = 400 \; V & Tv_J = 25^\circ C \\ V_{GE} = +15/{-8} \; V & Tv_J = 150^\circ C \\ \text{Rg.off} = 15 \; \Omega & Tv_J = 175^\circ C \end{array}$	-	129 199 212	-	ns
E <sub>ON</sub>	Turn–On Switching Loss (including diode reverse recovery loss)	$ \begin{array}{l} I_{C}=600 \text{ A}, \text{ V}_{CE}=400 \text{ V}, \text{ V}_{GE}=+15/-8 \text{ V},\\ Ls=20 \text{ nH}, \text{ Rg.on}=4,7 \Omega\\ di/dt (\text{Tv}_{J}=25^{\circ}\text{C})=4.77 \text{ A/ns}\\ di/dt (\text{Tv}_{J}=175^{\circ}\text{C})=3.78 \text{ A/ns}\\ \text{Tv}_{J}=25^{\circ}\text{C} \end{array} $	-	00.00	-	mJ
		$Tv_{J} = 150^{\circ}C$ $Tv_{J} = 150^{\circ}C$ $Tv_{J} = 175^{\circ}C$		22.93 35.87 37.70		
E <sub>OFF</sub>	Turn–Off Switching Loss	$ \begin{array}{l} I_{C} = 600 \; \text{A}, \; V_{CE} = 400 \; \text{V}, \; V_{GE} = +15/-8 \; \text{V}, \\ Ls = 20 \; \text{nH}, \; \text{Rg.off} = 15 \; \Omega \\ \text{dv/dt} \; (\text{Tv}_{J} = 25^{\circ}\text{C}) = 2.79 \; \text{V/ns} \\ \text{dv/dt} \; (\text{Tv}_{J} = 175^{\circ}\text{C}) = 2.05 \; \text{V/ns} \end{array} $	-		_	mJ
		$Tv_{J} = 25^{\circ}C$ $Tv_{J} = 150^{\circ}C$ $Tv_{J} = 175^{\circ}C$		33.57 47.30 49.09		
E <sub>SC</sub>	Minimum Short Circuit Energy Withstand	$V_{GE}$ = 15 V, $V_{CC}$ = 400 V $Tv_{J}$ = 25°C $Tv_{J}$ = 175°C	5	5		J

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

	Parameters	Conditions	Min	Тур	Max	Unit
V <sub>F</sub>	Diode Forward Voltage (Terminal)	$V_{GE} = 0 \text{ V}, \text{ I}_{C} = 600 \text{ A},$ $Tv_{J} = 25^{\circ}\text{C}$ $Tv_{J} = 150^{\circ}\text{C}$ $Tv_{J} = 175^{\circ}\text{C}$	_	1.39 1.36 1.34	1.80	V
		$V_{GE} = 0 \text{ V}, \text{ I}_{C} = 800 \text{ A},$ $Tv_{J} = 25^{\circ}\text{C}$ $Tv_{J} = 150^{\circ}\text{C}$ $Tv_{J} = 175^{\circ}\text{C}$		1.49 1.48 1.47		
E <sub>rr</sub>	Reverse Recovery Energy	$I_{F} = 600 \text{ A}, V_{R} = 400 \text{ V}, V_{GE} = -8 \text{ V},$ Rg.on = 4.7 $\Omega$ , -di/dt = 3.12 A/ns (175°C) Tv_{J} = 25°C Tv_{J} = 150°C	_	6.05 14.89	_	mJ
		$Tv_{J} = 175^{\circ}C$		17.12		
Q <sub>RR</sub>	Recovered Charge	$ \begin{array}{l} {\sf I}_{\sf F} = 600 \; {\sf A},  {\sf V}_{\sf R} = 400 \; {\sf V},  {\sf V}_{\sf GE} = -8 \; {\sf V}, \\ {\sf Rg.on} = 4.7 \; \Omega \; , \; -di/dt = 3.12 \; {\sf A}/ns \; (175^\circ C) \\ {\sf Tv}_{\sf J} = 25^\circ C \\ {\sf Tv}_{\sf J} = 150^\circ C \\ {\sf Tv}_{\sf J} = 175^\circ C \end{array} $	-	17.25 44.69 52.25	_	μC
Irr	Peak Reverse Recovery Current	$\begin{split} I_F &= 600 \text{ A},        $	_	222 311 325	_	A

## **CHARACTERISTICS OF INVERSE DIODE** (T<sub>VJ</sub> = 25°C, Unless Otherwise Specified)

## **SENSOR CHARACTERISTICS** ( $T_{VJ}$ = 25°C, Unless Otherwise Specified)

	Parameters	Conditions		Min	Тур	Max	Unit
T <sub>sense</sub>	Temperature sense	I <sub>F</sub> = 1 mA,	Tv <sub>J</sub> = 25°C		2.5		V
			Tv <sub>J</sub> = 150°C		1.7		
			$Tv_J = 175^{\circ}C$		1.5		
I <sub>sense</sub>	Current sense	$R_{shunt} = 10 \Omega$	I <sub>C</sub> = 1600 A		505		mV
			I <sub>C</sub> = 800 A		269		
			I <sub>C</sub> = 100 A		50		

4. Measured at chip level

## **ORDERING INFORMATION**

Part Number	Package	Shipping
NVG800A75L4DSB2	AHPM15-CEC Module Case MODHV (Pb-Free)	18 Units / 3x Tube



## **TYPICAL CHARACTERISTICS**



## **TYPICAL CHARACTERISTICS**

## **TYPICAL CHARACTERISTICS**



175°C

25°C

1600

#### 3.5 900 $I_{bias} = 1 \text{ mA}$ 800 $R_{shunt} = 10 \ \Omega$ 3.0 700 2.5 150°C < 600 I<sub>sense</sub> (mV) T<sub>sense</sub> (V) 2.0 500 400 1.5 300 1.0 200 0.5 100 0 0 10 60 110 160 0 400 800 1200 -40 TEMPERATURE (°C) I<sub>C</sub> (A) Figure 19. Temperature Sensor Characteristics Figure 20. Current Sensor Characteristic 775 750 V<sub>CES</sub> (V) 725 700 675 Verified by characterization / design, not by test 650 80 140 -40 20 200 T<sub>vj</sub> (°C)

## **TYPICAL CHARACTERISTICS**

Figure 21. Maximum Allowed V<sub>CE</sub>

General Note: These are preliminary values measured from a small number of DV units. Values will be updated based on higher quantity of PV measurements.

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#### MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

# **ONSEM**<sup>1</sup>.



# onsemí.

Gen II DSC AHPM15-CEC CASE MODHV

ISSUE O

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\*This information is generic. Please refer to device data sheet for actual part marking. Pb–Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

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